PCN Number:	20191119003	**PCN Date:**	Dec. 13, 2019
Title:	Datasheet for TS3L110		
Customer Contact:	PCN Manager	**Dept:**	Quality Services

Change Type:

☐	Assembly Site	☐	Design	☐	Wafer Bump Site
☐	Assembly Process	☒	Data Sheet	☐	Wafer Bump Material
☐	Assembly Materials	☐	Part number change	☐	Wafer Bump Process
☐	Mechanical Specification	☐	Test Site	☐	Wafer Fab Site
☐	Packing/Shipping/Labeling	☐	Test Process	☐	Wafer Fab Materials
				☐	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.
The product datasheet(s) is being updated as summarized below.
The following change history provides further details.

TEXAS INSTRUMENTS

TS3L110

SCDS176B – SEPTEMBER 2004 – REVISED OCTOBER 2019

Changes from Revision A (May 2019) to Revision B **Page**

- Change pin 10 to IC_1, pin 11 to IC_0, pin 13 to ID_1, and pin 14 to ID_0 in the *Pin Configuration and Functions*..... 3

The datasheet number will be changing.

Device Family	Change From:	Change To:
TS3L110	SCDS176A	SCDS176B

These changes may be reviewed at the datasheet links provided.

http://www.ti.com/product/TS3L110

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

TS3L110D	TS3L110DBQR	TS3L110DBQRG4	TS3L110DE4
TS3L110DG4	TS3L110DGVR	TS3L110DR	TS3L110PW
TS3L110PWR	TS3L110PWRE4	TS3L110PWRG4	TS3L110RGYR

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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